

DATE 5-25-62

SHEET 1 OF     

TMC SPECIFICATION NO. S-676

W. W.  
COMPILED

*BP*  
CHECKED

TITLE: CLEANING & INSPECTION OF PRINTED CIRCUIT

*WJ*  
APPROVED

1. Clean by using a small stiff non-metallic brush with Trichloroethelyne as a solvent to clean the printed surface.  
  
CAUTION: BE CAREFUL NOT TO REMOVE LETTERING WITH THE SOLVENT.
2. Visually inspect the circuit to insure that:
  - a) There are no cold solder joints.
  - b) The solder has flown completely around and through the eyelets.
  - c) The copper foil is completely tinned.
  - d) All components are solidly mounted.